

General Description

The MAX836/MAX837 micropower voltage monitors contain a 1.204V precision bandgap reference and a comparator in a SOT143 package. The MAX836 has an open-drain, n-channel output driver, while the MAX837 has a push-pull output driver. Two external resistors set the trip threshold voltage.

_Features

- ±1.25% Precision Voltage Threshold
- SOT143 Package
- Low Cost

TOP VIEW

- ♦ < 5µA Typical Supply Current</p>
- Open-Drain Output (MAX836)
 Push-Pull Output (MAX837)

Applications

Precision Battery Monitor Load Switching Battery-Powered Systems Threshold Detectors

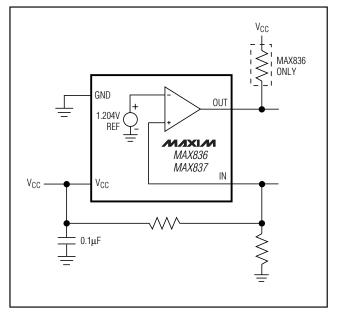
Ordering Information

PART*	TEMP RANGE	PIN- PACKAGE	TOP MARK	
MAX836EUS-T	-40°C to +85°C	4 SOT143-4	EQAA	
MAX837EUS-T	-40°C to +85°C	4 SOT143-4	EQAA	

*All devices available in tape-and-reel only. Contact factory for availability.

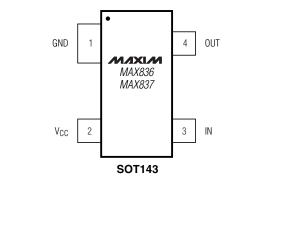
Devices are available in both leaded and lead-free packaging. Specify lead-free by replacing "-T" with "+T" when ordering.

Typical Operating Circuit





Pin Configuration



M/X/M

_ Maxim Integrated Products 1

For price, delivery, and to place orders, please contact Maxim Distribution at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

ABSOLUTE MAXIMUM RATINGS

V _{CC} , OUT to GND (MAX836)	-0.3V to 12V
IN, OUT to GND (MAX837)	
Input Current	
Vcc	
IN	10mA
Output Current, OUT	

Rate of Rise, V _{CC}	100V/µs
Continuous Power Dissipation	
SOT143 (derate 4mW/°C above +70°C)	320mW
Operating Temperature Range	40°C to +85°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = +2.5V to +11.0V, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25^{\circ}$ C.)

PARAMETER	SYMBOL		CONDITION	IS	MIN	ТҮР	MAX	UNITS	
Operating Voltage Range (Note 1)	Vcc				2.5		11.0	V	
Supply Current (Note 2)		V _{IN} = 1.16V, OUT = low	V _{CC} = 3.6V	TA = +25°C		3.5	6.5	μΑ	
				$T_A = T_{MIN}$ to T_{MAX}			10		
			V _{CC} = full operat	ing range			15		
	Icc	V _{IN} = 1.25V, OUT = high	V _{CC} = 3.6V	TA = +25°C		2.0	5.0		
				$T_A = T_{MIN}$ to T_{MAX}			8.0		
			V _{CC} = full operat	ing range			13		
Trip Threshold Voltage	V _{TH}	V _{IN} falling	$T_A = +25^{\circ}C$		1.185	1.204	1.215	5 V	
			$T_A = -40^{\circ}C \text{ to } +8$	5°C	1.169	1.204	1.231	v	
Trip Threshold Voltage Hysteresis	VHYST	$V_{CC} = 5V$, IN = low to high			6		mV		
IN Operating Voltage Range (Note 1)	VIN						Vcc - 1	V	
IN Leakage Current (Note 3)	l _{IN}	V _{IN} = V _{TH}			±З	±12	nA		
Propagation Delay	tPL	V _{CC} = 5.0V, 50mV overdrive			80		μs		
Glitch Immunity		V _{CC} = 5.0V, 100mV overdrive			35		μs		
OUT Rise Time	t _{RT}	V _{CC} = 5.0V, no load (MAX837 only)			260		ns		
OUT Fall Time	tFT	$V_{CC} = 5.0V$, no load (MAX836 pull-up = 10k Ω)			680		ns		
Output Leakage Current (Note 4)	ILOUT	V _{IN} > V _{THMAX} (MAX836 only)				±1	μA		
Output-Voltage High	Voh	VIN > VTHMAX, ISOURCE = 500µA (MAX837 only)		V _{CC} - 0.5	5		V		
Output-Voltage Low	Vol	VIN < VTHMIN, ISINK = 500µA				0.4	V		

Note 1: The voltage-detector output remains in the direct state for V_{CC} down to 1.2V when V_{IN} \leq V_{CC} / 2.

Note 2: Supply current has a monotonic dependence on V_{CC} (see the Typical Operating Characteristics).

Note 3: IN leakage current has a monotonic dependence on V_{CC} (see the Typical Operating Characteristics).

Note 4: The MAX836 open-drain output can be pulled up to a voltage greater than V_{CC}, but may not exceed 11V.

Typical Operating Characteristics

 $(V_{CC} = +5V, R_{LOAD} = 1M\Omega, R_{PULLUP} = 10k\Omega$ (MAX836 only), $T_A = +25^{\circ}C$, unless otherwise noted.)

TRIP THRESHOLD VOLTAGE

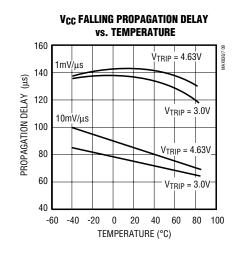
SUPPLY CURRENT vs. IN VOLTAGE vs. TEMPERATURE **SUPPLY CURRENT vs. SUPPLY VOLTAGE** 1.207 16 5.0 AX838/7 (14 TRIP THRESHOLD VOLTAGE (V) 1.206 4.0 (hA) (HA) 12 1.205 SUPPLY CURRENT SUPPLY CURRENT 10 3.0 Vcc = 11\ 1.204 8 2.0 6 1.203 2 1.0 /_{CC} = 3.6V 1.202 2 V_{IN} = 1.22V 0 1.201 ٥ -60 -40 -20 0 20 40 60 80 100 3 4 5 6 7 8 9 10 11 12 0 1 2 3 4 5 6 7 8 9 10 11 12 2 TEMPERATURE (°C) V_{CC} (V) VIN (V) **IN LEAKAGE CURRENT MAX837 OUTPUT VOLTAGE** IN LEAKAGE CURRENT vs. IN VOLTAGE vs. SUPPLY VOLTAGE vs. OUTPUT SOURCE CURRENT 5.5 80 4.8 $\dot{V}_{CC} = 11V$ 5.0 70 4.4 $T_A = -40^{\circ}C$ 4.5 $T_A = -40^{\circ}C$ (hA) (nA) 60 **OUTPUT VOLTAGE (V)** 4.0 4.0 IN LEAKAGE CURRENT IN LEAKAGE CURRENT 3.5 50 -40°C 3.6 3.0 40 2.5 $T_A = +25^{\circ}C$ = +25 3.2 T_A = +25°C 30 2.0 TΔ 2.8 1.5 20 T_A = +85°C T_A = +85°C 1.0 10 2.4 $T_A = +85^{\circ}C$ 0.5 V_{IN} = 1.2V Ω 20 0 1 2 3 7 8 0.01 0 4 5 6 9 10 11 3 4 5 7 8 9 10 11 12 0.1 1 10 100 2 6 V_{IN} (V) OUTPUT SOURCE CURRENT (mA) V_{CC} (V) SHORT-CIRCUIT SINK CURRENT vs. **OUTPUT LOW VOLTAGE OUTPUT VOLTAGE** vs. SUPPLY VOLTAGE SUPPLY VOLTAGE vs. OUTPUT SINK CURRENT 10,000 130 70 T_A = -40°C T_A = +25°C 120 SHORT-CIRCUIT SINK CURRENT (mA) 60 = +85°C 110 $I_{SINK} = 500 \mu A$ TΔ OUTPUT LOW VOLTAGE (mV) 1,000 100 50 OUTPUT VOLTAGE (mV) T_A = -40°C 90 . Т_А = +25°С 100 40 80 70 30 T_A = +85°C 10 60 20 50 1 40 10 30 0.1 20 0 0.01 100 2 3 4 5 6 7 8 9 10 11 12 2 3 4 5 6 7 8 9 10 11 12 0.1 10 1 OUTPUT SINK CURRENT (mA) V_{CC} (V) V_{CC} (V)

3

MAX836/MAX83;

Typical Operating Characteristics (continued)

 $(V_{CC} = +5V, R_{LOAD} = 1M\Omega, R_{PULLUP} = 10k\Omega$ (MAX836 only), $T_A = +25^{\circ}C$, unless otherwise noted.)



Pin Description

PIN	NAME	FUNCTION
1	GND	System Ground
2	Vcc	System Supply Input
3	IN	Noninverting Input to the Comparator. The inverting input connects to the internal 1.204V bandgap reference.
4	OUT	Open-Drain (MAX836) or Push-Pull (MAX837) Output

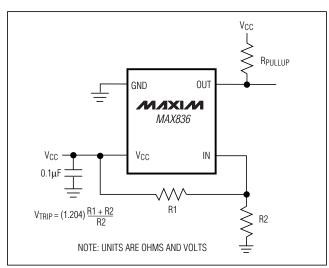
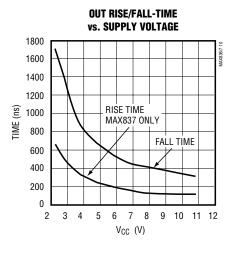


Figure 1. Programming the Trip Voltage, VTRIP



Detailed Description

The MAX836/MAX837 micropower voltage monitors contain a 1.204V precision bandgap reference and a comparator (see the *Typical Operating Circuit*). The only difference between the two parts is the structure of the comparator output driver. The MAX836 has an open-drain n-channel output driver that can be pulled up to a voltage higher than V_{CC}, but under 11V. The MAX837's output is push-pull, and can both source and sink current.

Programming the Trip Voltage

Two external resistors set the trip voltage, VTRIP (Figure 1). VTRIP is the point at which the applied voltage (typically V_{CC}) toggles OUT. The MAX836/MAX837's high input impedance allows large-value resistors without compromising trip-voltage accuracy. To minimize current consumption, select a value for R2 between 500k Ω and 1M Ω , then calculate R1 as follows:

$$R1 = R2\left(\frac{V_{TRIP}}{V_{TH}} - 1\right)$$

where VTRIP = desired trip voltage (in volts), VTH = threshold trip voltage (1.204V).

Applications Information

Adding Hysteresis

Hysteresis adds noise immunity to the MAX836/MAX837 and prevents repeated triggering when V_{IN} is near the threshold trip voltage. Figure 2 shows how to add hysteresis to the comparator. The technique is similar for



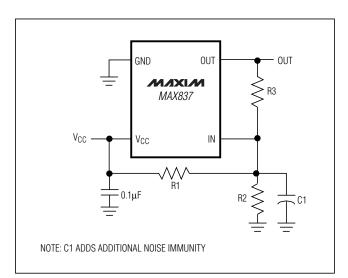
both parts. For the MAX836, select the ratio of resistors R1 and R2 so that IN sees 1.204V when the monitor voltage falls to or rises above the desired trip point (VTRIP). R3 adds hysteresis and is typically an order of magnitude larger than R1 or R2. The current through R1 and R2 should be at least 500nA to ensure that the 12nA maximum input current does not shift the trip point significantly. Capacitor C1 adds additional noise rejection.

Monitoring Voltages Other than VCC

The MAX836/MAX837 can monitor voltages other than V_{CC} (Figure 3). Calculate V_{TRIP} as shown in the *Programming the Trip Voltage* section. The monitored voltage (V_{MON}) is independent of V_{CC}. V_{IN} must be 1V less than V_{CC}.

Heater Temperature Control

Figure 4 shows a basic heater temperature-control circuit. Upon power-up, OUT is high and the n-channel MOSFET turns on. Current flows through the heating element (R4), warming the surrounding area. R2 is a negative-temperature-coefficient thermistor and as temperature increases, its resistance decreases. As the thermistor heats up and its resistance decreases, the MAX837's voltage at IN decreases until it reaches the 1.204V threshold voltage. At this point, OUT goes low, turning off the heating element. The thermistor cools and the voltage at IN rises until it overcomes the MAX837's hysteresis (6mV). OUT returns high when this point is reached, turning on the heating element again. This cycle repeats as long as power is applied.





Determine the thermistor's resistance (R2) at the desired temperature. Then, using R2's resistance and half the resistance of R3, calculate R1's value with the following formula:

R1 = (R2 + R3)
$$\left(\frac{V_{CC}}{1.204} - 1\right)$$

Chip Information

TRANSISTOR COUNT: 54

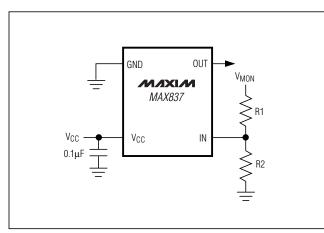


Figure 3. Monitoring Voltages Other than V_{CC}

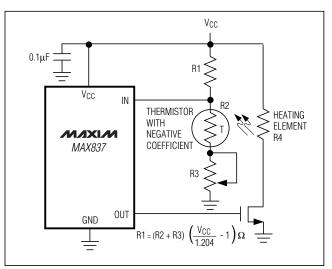
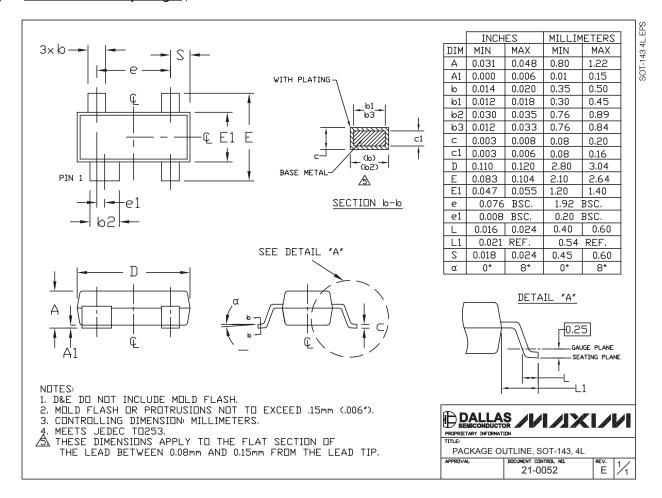


Figure 4. Heater Temperature Control

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)



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